



TSicTM101/106/201/206/301/306/506 Rapid Response, Low-Cost Temperature Sensor IC with Analog or digital Output Voltage





Brief Description

The TSic[™] temperature sensor IC family are fully tested and calibrated sensors with absolute measurement accuracy on delivery, no further calibration needed.

The TSic[™] combines outstanding accuracy with long term stability, yet it is very simple to use. The TSic[™] series is specifically designed for high performance, cost-effective solutions for sensing temperature in building automation, automotive, industrial, office automation, white goods and low-power/mobile applications.

TSic[™] employs a high precision bandgap reference with PTAT output; a low-power, precision ADC; and an on-chip DSP core with EEPROM to precisely calibrate the output temperature signal.

The TSicTM series includes ICs with two linear analog signal output options, such as standard $0 \sim 1$ Vout (Supply voltage (V+) = 3.0V to 5.5V) or ratiometric ($10 \sim 90\%$ of supply voltage); or the digital serial output signal for interfacing with microcontrollers.

Standard TSic[™] devices are available with digital (ZacWire, TSic[™]x06) or analogue (0-1V, TSic[™]x01) output Signal.

Features

- Low cost, precision temperature sensor
- Analog 0 to 1 Volt signal output¹⁾
- Resolution: 0.1°C(0.034°C TSic™506)
- Single-wire 11-bit digital serial signal output²⁾
- Communication range > 10 meters²⁾
- Accuracy: up to ±0.1°C over span of 40°C
- Wide measurement range: -50 to +150 °C (TSic[™] 10x/20x/30x) -10 to +60 °C (TSic[™] 506)
- Signal read-out every 0.1s (other rates available on request)
- Supply Voltage 3.0V to 5.5V; high accuracy operation in range 4.5V to 5.5V¹⁾
- Package: 8-pin SOP, 3-pin TO-92, Die on Wafer
- Low quiescent current to minimize selfheating and power consumption (45µA typ.)

 System-on-chip based on advanced mixedsignal CMOS technology integrating precision temperature sensing bandgap reference with proportional-to-absolutetemperature (PTAT) output, digital signal processor (DSP) core, and electrically erasable memory (EEPROM)

Benefits

- Several accuracy classes available with 100% upward compatibility
- No calibration by customer needed; absolute calibration specified
- Simple to integrate, reducing cost and time for application-development
- Fast data measurement optimal for temperature control
- Packages for standard SMD, THT or application specific assembly
- Very low power consumption ideal for mobile and standard applications
- Field reconfiguration/recalibration option available (high volume customers only)

Available Support

For TSic[™] evaluation ZMDI provides a special Evaluation Tool. (Ordering Code: TSic Lab Kit) Further application support is available through the hotline:

email: <u>micsensor@yeah.net</u> Phone: +86 523 8815 5558

TSic[™]101/106/201/206/301/306/506 Overview



1) For TSic[™] with analog output only (TSic[™]101/201/301) 2) For TSic[™] with digital output only

(TSic™106/206/306/506)

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1 Electrical Characteristics

1.1. Absolute Maximum Ratings

Table 1-1Absolute Maximum Ratings

Symbol	Parameter	Min	Мах	Unit
V+	Supply Voltage	-0.3	6.0	V _{DC}
Vina, Vouta	Voltages at analog I/O – Pins	-0.3	V_{DDA} +0.3	V _{DC}
T _{Stor}	Storage temperature	-50	150	°C

1.2. Operating Conditions

Table 1-2 Operating Conditions

Symbol	Parameter	Min	Тур	Max	Unit
V+	Supply ¹⁾ Voltage to Gnd	3.0	5.0	5.5	V
I _{V+}	Supply Current ²⁾³⁾ @ V+ = 3.3V, RT			200	μA
I _{V+}	Supply Current ²⁾⁴⁾ @ V+ = 3.3V, RT	30	45	80	μA
T _{amb}	Ambient Temperature ⁵⁾ Range	-50		150	°C
C _{V+}	External Capacitance between V+ and GND ⁶⁾ (C _{V+})	80	100	470	nF
CL	Output Load Capacitance (C _L) ⁴⁾			15	nF
	Output Load Resistance between signal and GND (or V+) ³⁾	47	100		kΩ
	Output Load Resistance between signal and GND (or V+) ⁴⁾	1			MΩ

1) Best accuracy with supply voltage 4.5V – 5.5V. With supply voltage 3.5V – 4.5V(TSic[™]101/201/301) 3.5V – 4.5V

(TSic™106/206/306/506) accuracy reduced

2) Without load

3) For TSic[™] with analog output only (TSic[™]101/201/301)

4) For TSic[™] with digital output only (TSic[™]106/206/306/506)

5) Output signal is limited to this ambient temperature ±3°C (with regard to calibration, offset and gain)

6) Recommended as close to TSic V+ and GND-Pins as possible



2 Accuracy of Temperature Measurement

The accuracy describes the specification plus quantization error of 1 bit (0.1°C). This device gets calibrated at a supply voltage of 5V. For applications which require the best accuracy at a supply voltage of 3V the possibility to create a customer specific 3V calibrated device exists. Other TSic[™] products with customer specific calibration are available on request (i.e. with special calibration where the 80°C span (bandgap) with the high precision temperature range of ± 0.5 °C is shifted to another (lower or higher) temperature range).

Figure 2-1	Accuracy Overview TSi	c™ Family
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ac 3			ac 3
	 Range T2	·	
	Range T3	F	

Table 2-1	Accuracv TSic ™101/106/201/206/301/306/5	6 06 1)

		T-Range 3					
			T-Ra	inge 2			
		T-Ran	ge 1				
Product Version	Resolution	T-Range 1	Accuracy 1	T-Range 2	Accuracy 2	T-Range 3	Accuracy 3
TSic 101/106	0.1°C	+15°C to +25°C	<±0.5°C	+0°C to +40°C	<±1.0°C	-50°C to +150°C	no limits (typ ±1.5°C)
TSic 201/206	0.1°C	+10°C to +90°C	<±0.5°C	-20°C to +110°C	<+0.95°C >-0.5°C	-50°C to +150°C	<+2.0°C >-0.5°C
TSic 301/306	0.1°C	+10°C to +90°C	<±0.3°C	-20°C to +110°C	<+0.95°C >-0.3°C	-50°C to +150°C	<+2.0°C >-0.5°C
TSic 506	0.034°C	+5°C to +45°C	<±0.1°C	-5°C to +55°C	<+0.2°C >-0.1°C	-10°C to +60°C	<+0.3°C >-0.1°C
1) Accuracy	for supply voltag	ge within V+ = 4.5V	' to 5.5V				



3 Output Examples for TSicTM101/106/201/206/301/306/506

Table 3-1 Output Examples for TSic 1101/106/201/206/301/306/506

Temp (°C)	Temp (°F)	Analog 0~1V (TSic™ 101/201/301) ¹⁾⁴⁾	Digital (TSic™ 106/206/306) ¹⁾³⁾	Digital (TSic™ 506) ²⁾³⁾
-50	-58	0.000	0x000	-
-10	14	0.200	0x199	0x000
0	32	0.250	0x200	0x124
25	77	0.375	0x2FF	0x3FF
60	140	0.550	0x465	0x7FF
125	257	0.875	0x6FE	-
150	302	1.000	0x7FF	-
A) Tanan anatana Masaanaa			(Mide Dense Dender)	

1) Temperature Measurement Range -50(LT)°C to 150(HT)°C or -58°F to 302°F (Wide Range Device)

2) Temperature Measurement Range -10(LT)°C to 60(HT)°C or 14°F to 140°

3) Temperature = (Digital_signal/2047*(HT-LT)+LT) [°C]

4) Temperature = (Sig[Volt]*(HT-LT)+LT) [°C]

4 Lifetime for TSicTM101/106/201/206/301/306/506 Devices

Table 4-1 Output Examples for TSic 1101/106/201/206/301/306/506

Operating Temperature	expected Lifetime
140°C150°C	min. 1500h
125°C140°C	min. 3000h



5 Pin configuration and Package

5.1. Pin Configuration

Available packages for the TSic[™]101/106/201/206/301/306/506 is are SOP8 and TO92 package.



Figure 5-1 TSic ™101/106/201/206/301/306/506 Pin Diagram SOP8

Table 5-1	TSic™101/106/201/206/301/306/506	PIN Diagram	SOP8
		i in Diagram (501 0

Pin	Name	Description	
1	V+	Supply voltage (3.0-5.5V)	
2	Signal	Temperature output signal	
4	GND	Ground	
3, 5-8	TP/NC	Test pin / NC Do not connect	



TSic ™101/106/201/206/301/306/506 Pin Diagram TO-92 Figure 5-2



Table 5-2 TSic 1101/106/201/206/301/306/506 PIN Diagram TO-92

Pin	Name	Description	
1 ¹⁾	GND	Ground	
2	Signal	Temperature output signal	
31)	V+	Supply Voltage (3.0-5.5V)	
1) The e-line package (discontinued) has swapped pins 1 and 3			

The e-line package (discontinued) has swapped pins





5.2. Package Outline





Table 5-3 SOP 8 Package dimensions [mm]

÷		
	min	max
А	1,55	1,95
A ₁	0,1	0,3
A2	1,4	1,8
b₽	0,35	0,49
с	0,15	0,25
D	4,8	5
E	3,8	4,0
e _{nom}	1,	27
HE	5,8	6,3
k	0,3	
LP	0,4	
θ	0°	8°
Z	0,635	

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Table 5-4TO-92 Package dimensions [mm]

	min	max
A	2,16	2,41
а	1,10	1,20
b	0,41	0,495
с	0,41	0,495
D	3,61	4,01
E	4,37	4,77
е	1,27	
L	13,0	13,97







Table 5-5	TSic ™101/106/201/206/301/306/506	PIN Diagram Bare Die
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Pin	Name	X Coordinate [μm]	Υ Coordinate [μm]	Notes
VSSd	GND	215.8	1371.9	VSS must be connected.
VSSa	GND	356.2	1371.9	VSS analog must be connected.
Signal	Signal	524.9	1371.9	SIG™
VDD	V+	851.5	1371.9	VDD must be connected.
VDDa	V+	996.9	1371.9	VDD analog must be connected.



6 Additional Documents

Document ZACWire Technical Note PCN TSic™ Ordering Guide File Name IST_TSic_ZACwire_Vx.x Digital Output_xdatex.pdf PCN_eline_Jan07.pdf TSic_Ordering_Guide_Rev.x.x.pdf

Visit ZMDI's website <u>www.mic-sensor.com</u> or contact your nearest sales office for the latest version of these documents.

7 Document Revision History

Revision	Date	Description
3.5	August 11, 2006	Update after review
3.6	June 12, 2007	Update after review
3.7	November 7, 2008	- Combination of documents: datasheet TSic™ 10x to 50x and Packaging information - changes in Pin configuration and Package



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